

### Small Signal Diode



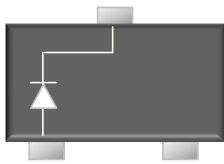
#### Features

- ◇ Fast switching speed
- ◇ Surface device type mounting
- ◇ Moisture sensitivity level 1
- ◇ Matte Tin(Sn) lead finish with Nickel(Ni) underplate
- ◇ Pb free version and RoHS compliant
- ◇ Green compound (Halogen free) with suffix "G" on packing code and prefix "G" on date code

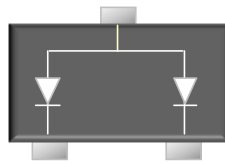
#### Mechanical Data

- ◇ Case :SOT-23 small outline plastic package
- ◇ Terminal: Matte tin plated, lead free., solderable per MIL-STD-202, Method 208 guaranteed
- ◇ High temperature soldering guaranteed: 260°C/10s
- ◇ Weight : 0.008gram (approximately)
- ◇ Marking Code : JS,JS2,JS3,JS4

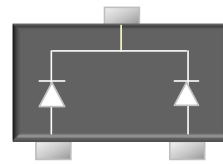
#### Pin Configuration



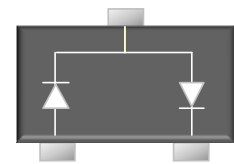
**BAS21**



**BAS21A**



**BAS21C**



**BAS21S**

#### Ordering Information

Package	Part No.	Packing	Marking
SOT-23	BAS21 RF	3K / 7" Reel	JS
SOT-23	BAS21A RF	3K / 7" Reel	JS2
SOT-23	BAS21C RF	3K / 7" Reel	JS3
SOT-23	BAS21S RF	3K / 7" Reel	JS4
SOT-23	BAS21 RFG	3K / 7" Reel	JS
SOT-23	BAS21A RFG	3K / 7" Reel	JS2
SOT-23	BAS21C RFG	3K / 7" Reel	JS3
SOT-23	BAS21S RFG	3K / 7" Reel	JS4

#### Maximum Ratings and Electrical Characteristics

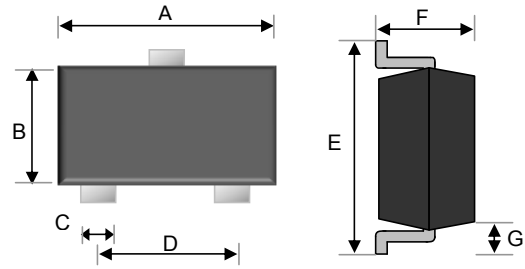
Rating at 25°C ambient temperature unless otherwise specified.

#### Maximum Ratings

Type Number	Symbol	Value	Units
Power Dissipation	$P_D$	225	mW
Repetitive Peak Reverse Voltage	$V_{RRM}$	250	V
Repetitive Peak Forward Current	$I_{FRM}$	625	mA
Mean Forward Current	$I_O$	200	mA
Non-Repetitive Peak Forward Surge Current (Note 1)	$I_{FSM}$	1	A
Thermal Resistance (Junction to Ambient) (Note 2)	$R_{\theta JA}$	500	°C/W
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to + 150	°C

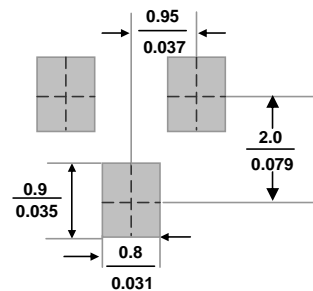
Notes:1. Test Condition : 8.3ms Single half Sine-Wave Superimposed on Rated Load (JEDEC Method) Pulse Width=1  $\mu$ sec  
 Notes:2. Valid provided that electrodes are kept at ambient temperature

#### SOT-23



Dimensions	Unit (mm)		Unit (inch)	
	Min	Max	Min	Max
A	2.80	3.00	0.110	0.118
B	1.20	1.40	0.047	0.055
C	0.30	0.50	0.012	0.020
D	1.80	2.00	0.071	0.079
E	2.25	2.55	0.089	0.100
F	0.90	1.20	0.035	0.043
G	0.550 REF		0.022 REF	

#### Suggested PAD Layout



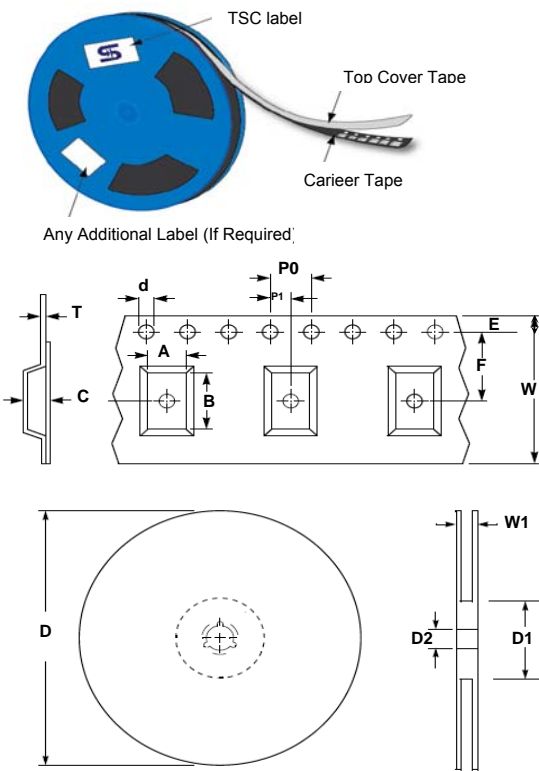
**Small Signal Diode**

**Electrical Characteristics**

**Electrical Characteristics**

Type Number		Symbol	Min	Max	Units
Reverse Breakdown Voltage	$I_R = 100\mu A$	$V_{(BR)}$	250	-	V
Forward Voltage	$I_F = 100mA$	$V_F$	-	1.00	V
	$I_F = 200mA$		-	1.25	V
Reverse Leakage Current	$V_R = 200V$	$I_R$	-	0.1	$\mu A$
Junction Capacitance	$V_R = 1V, f = 1.0MHz$	$C_J$	-	5	pF
Reverse Recovery Time	$I_F = I_R = 10mA, R_L = 100\Omega, I_{RR} = 1mA$	$T_{rr}$	-	50.0	ns

**Tape & Reel specification**

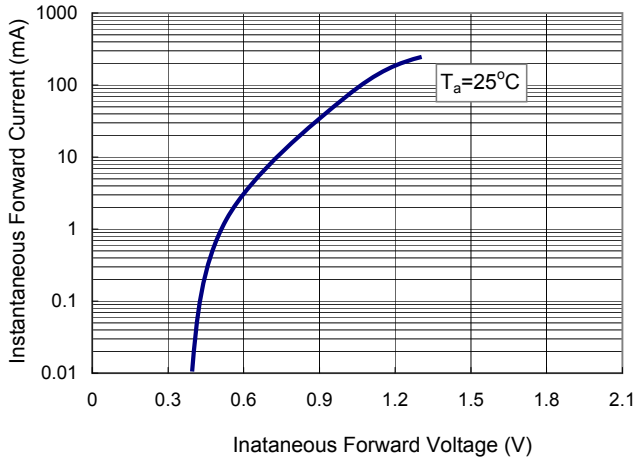


Item	Symbol	Dimension(mm)
Carrier width	A	3.15 ±0.10
Carrier length	B	2.77 ±0.10
Carrier depth	C	1.22 ±0.10
Sprocket hole	d	1.50 ± 0.10
Reel outside diameter	D	178 ± 1
Reel inner diameter	D1	55 Min
Feed hole width	D2	13.0 ± 0.20
Sprocket hole position	E	1.75 ±0.10
Punch hole position	F	3.50 ±0.05
Sprocket hole pitch	P0	4.00 ±0.10
Embossment center	P1	2.00 ±0.05
Overall tape thickness	T	0.229 ±0.013
Tape width	W	8.10 ±0.20
Reel width	W1	12.30 ±0.20

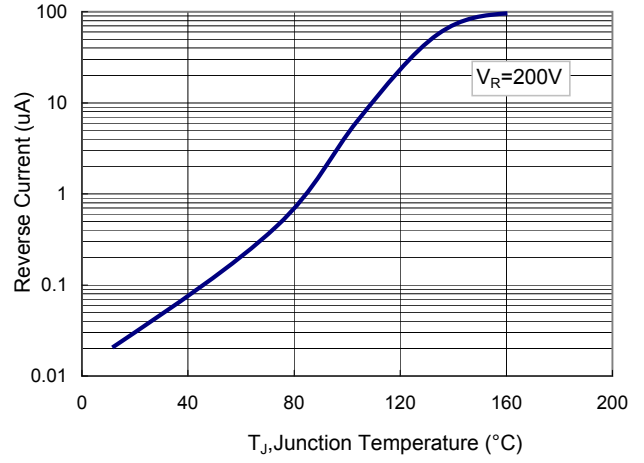
**Small Signal Diode**

**Rating and Sharacteristic Curves**

**FIG 1 Typical Forward Characteristics**



**FIG 2 Reverse Current vs Junction Temperature**



**FIG 3 Admissible Power Dissipation Curve**

